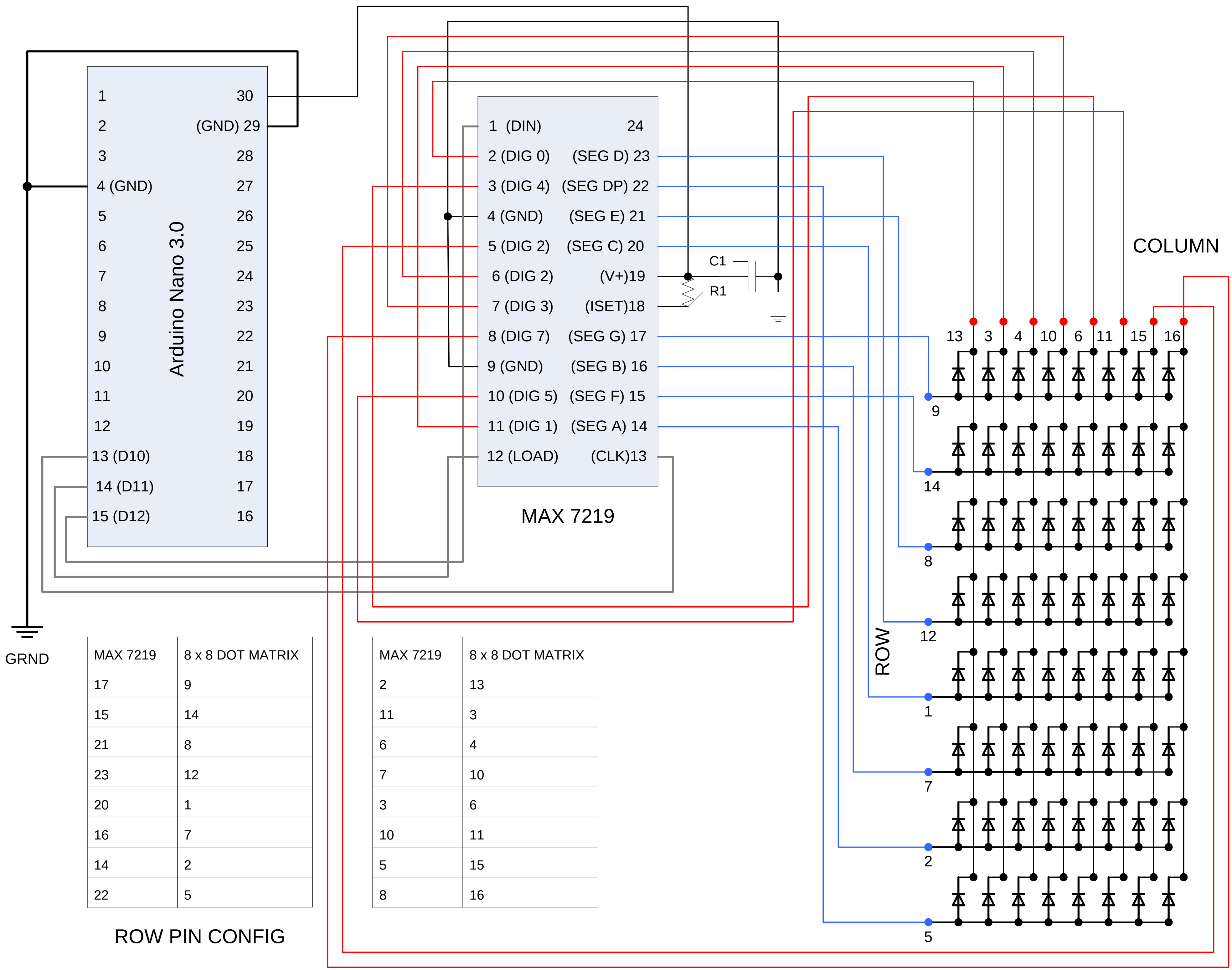


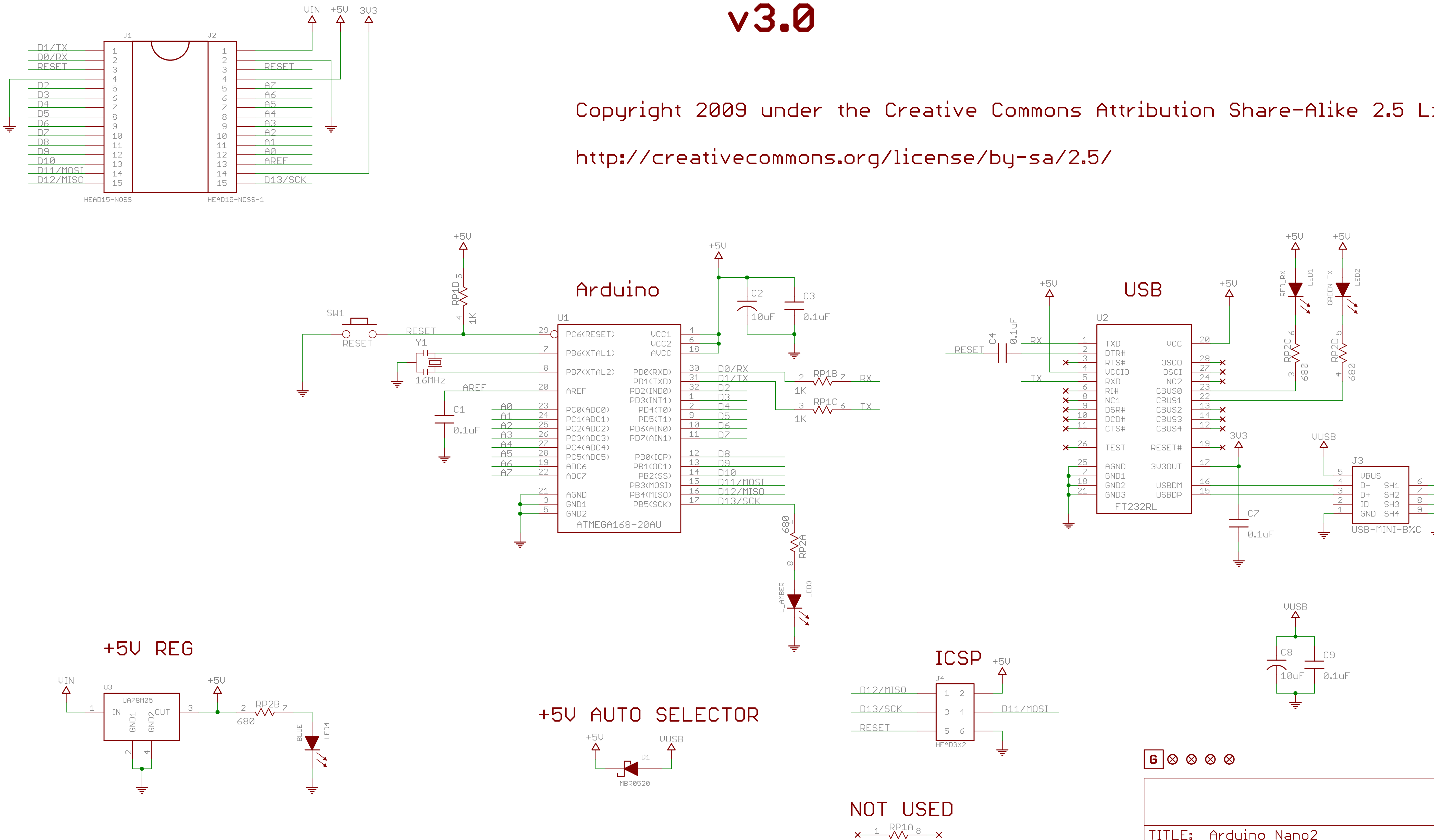
MAX 7219	8 x 8 DOT MATRIX
17	9
15	14
21	8
23	12
20	1
16	7
14	2
22	5

ROW PIN CONFIG

MAX 7219	8 x 8 DOT MATRIX
2	13
11	3
6	4
7	10
3	6
10	11
5	15
8	16

Arduino Nano

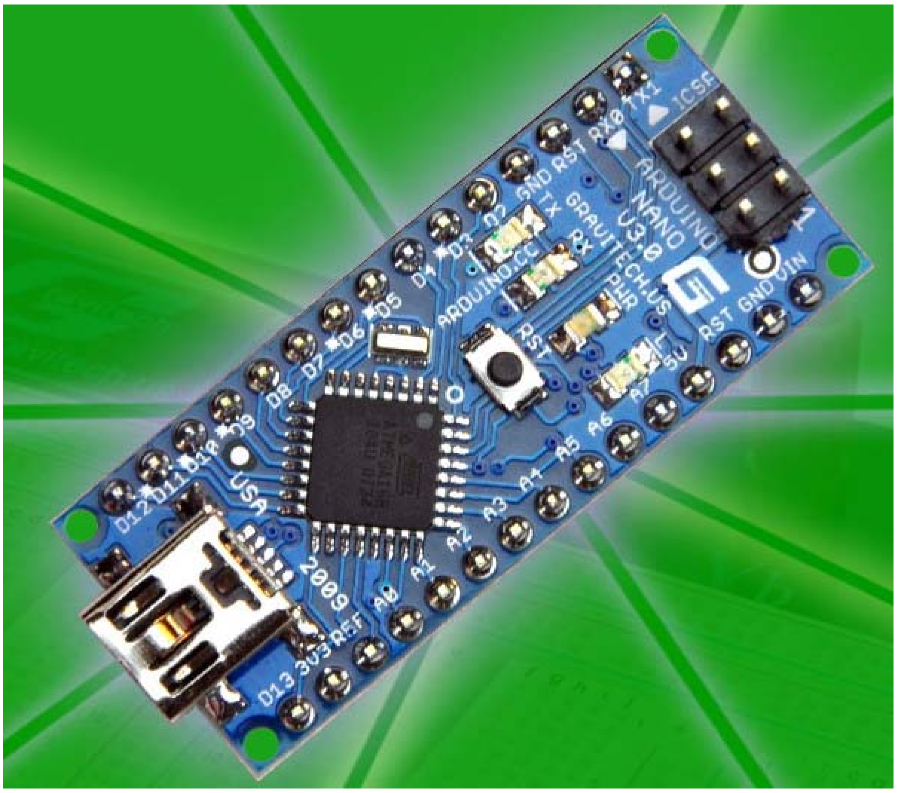
v3.0



TITLE: Arduino Nano2	
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Arduino Nano *(V3.0)*

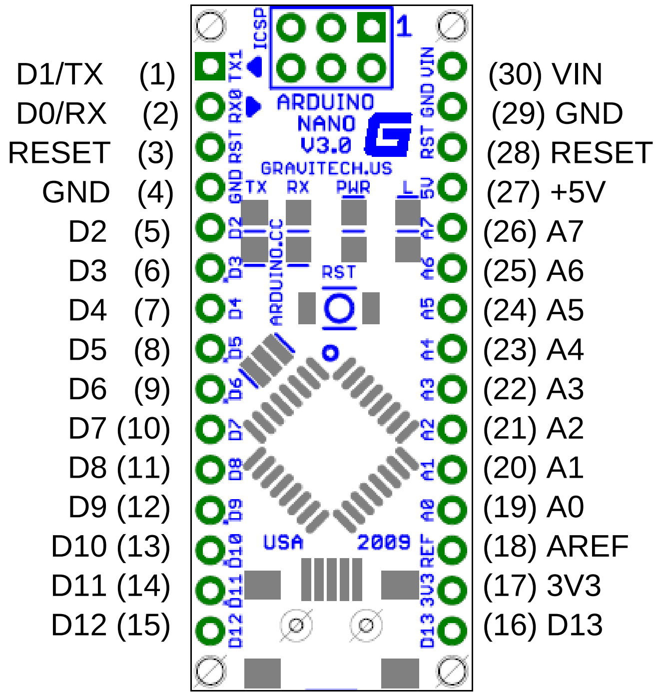
User Manual



More information:

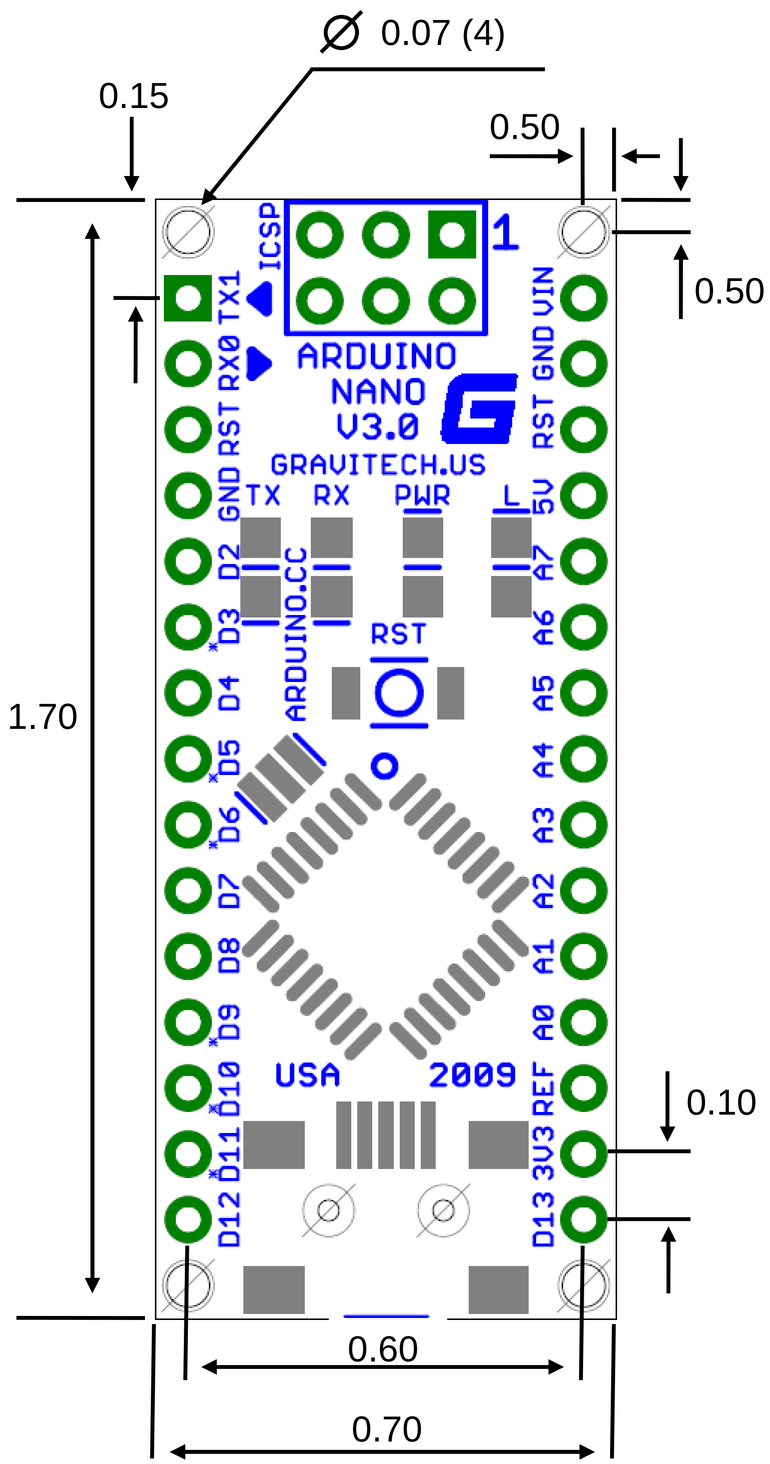
www.arduino.cc Rev 3.0

Arduino Nano Pin Layout



Pin No.	Name	Type	Description
1-2, 5-16	D0-D13	I/O	Digital input/output port 0 to 13
3, 28	RESET	Input	Reset (active low)
4, 29	GND	PWR	Supply ground
17	3V3	Output	+3.3V output (from FTDI)
18	AREF	Input	ADC reference
19-26	A0-A7	Input	Analog input channel 0 to 7
27	+5V	Output or Input	+5V output (from on-board regulator) or +5V (input from external power supply)
30	VIN	PWR	Supply voltage

Arduino Nano Mechanical Drawing



Jameco Part Number 312160

19-4452; Rev 4; 7/03

MAXIM

Serially Interfaced, 8-Digit LED Display Drivers

General Description

The MAX7219/MAX7221 are compact, serial input/output common-cathode display drivers that interface microprocessors (µPs) to 7-segment numeric LED displays of up to 8 digits, bar-graph displays, or 64 individual LEDs. Included on-chip are a BCD code-B decoder, multiplex scan circuitry, segment and digit drivers, and an 8x8 static RAM that stores each digit. Only one external resistor is required to set the segment current for all LEDs. The MAX7221 is compatible with SPI™, QSPI™, and MICROWIRE™, and has slew-rate-limited segment drivers to reduce EMI.

A convenient 4-wire serial interface connects to all common µPs. Individual digits may be addressed and updated without rewriting the entire display. The MAX7219/MAX7221 also allow the user to select code-B decoding or no-decode for each digit.

The devices include a 150µA low-power shutdown mode, analog and digital brightness control, a scan-limit register that allows the user to display from 1 to 8 digits, and a test mode that forces all LEDs on.

For applications requiring 3V operation or segment blinking, refer to the MAX6951 data sheet.

Applications

Bar-Graph Displays	Panel Meters
Industrial Controllers	LED Matrix Displays

Features

- ♦ **10MHz Serial Interface**
- ♦ **Individual LED Segment Control**
- ♦ **Decode/No-Decode Digit Selection**
- ♦ **150µA Low-Power Shutdown (Data Retained)**
- ♦ **Digital and Analog Brightness Control**
- ♦ **Display Blanked on Power-Up**
- ♦ **Drive Common-Cathode LED Display**
- ♦ **Slew-Rate Limited Segment Drivers for Lower EMI (MAX7221)**
- ♦ **SPI, QSPI, MICROWIRE Serial Interface (MAX7221)**
- ♦ **24-Pin DIP and SO Packages**

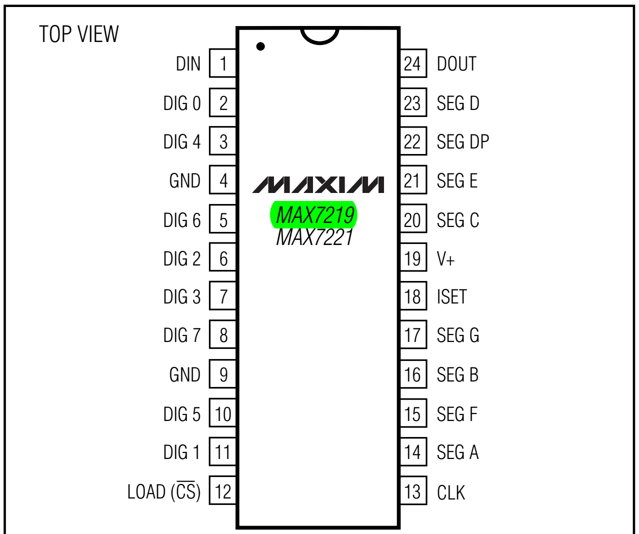
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX7219CNG	0°C to +70°C	24 Narrow Plastic DIP
MAX7219CWG	0°C to +70°C	24 Wide SO
MAX7219C/D	0°C to +70°C	Dice*
MAX7219ENG	-40°C to +85°C	24 Narrow Plastic DIP
MAX7219EWG	-40°C to +85°C	24 Wide SO
MAX7219ERG	-40°C to +85°C	24 Narrow CERDIP

Ordering Information continued at end of data sheet.

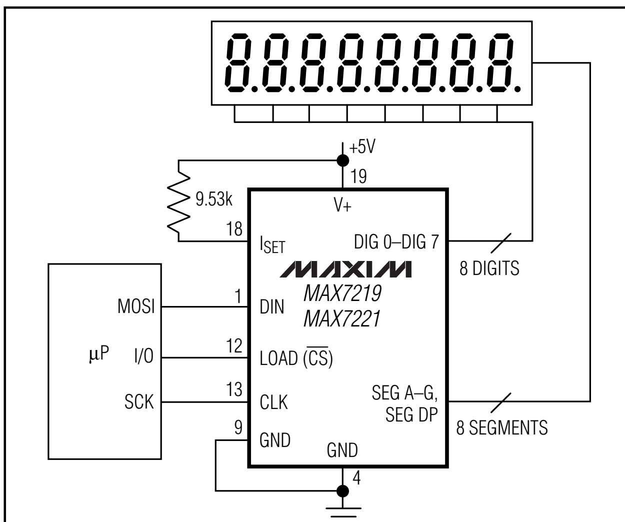
**Dice are specified at T_A = +25°C.*

Pin Configuration



DIP/SO

Typical Application Circuit



8-DIGIT µP DISPLAY

SPI and QSPI are trademarks of Motorola Inc. MICROWIRE is a trademark of National Semiconductor Corp.

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Serially Interfaced, 8-Digit LED Display Drivers

ABSOLUTE MAXIMUM RATINGS

Voltage (with respect to GND)
- V+ ....-0.3V to 6V
- DIN, CLK, LOAD, $\overline{CS}$ ....-0.3V to 6V
- All Other Pins..-0.3V to (V+ + 0.3V)

Current
- DIG0–DIG7 Sink Current..500mA
- SEGA–G, DP Source Current..100mA

Continuous Power Dissipation (T_A = +85°C)
- Narrow Plastic DIP (derate 13.3mW/°C above +70°C)..1066mW
- Wide SO (derate 11.8mW/°C above +70°C).................941mW
- Narrow CERDIP (derate 12.5mW/°C above +70°C) ...1000mW

Operating Temperature Ranges (T_{MIN} to T_{MAX})
- MAX7219C_G/MAX7221C_G ....0°C to +70°C
- MAX7219E_G/MAX7221E_G ....-40°C to +85°C

Storage Temperature Range ....-65°C to +160°C
Lead Temperature (soldering, 10s) ....+300°C

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V+ = 5V ±10%, R_{SET} = 9.53kΩ ±1%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Supply Voltage	V+		4.0		5.5	V
Shutdown Supply Current	I+	All digital inputs at V+ or GND, T_A = +25°C			150	µA
Operating Supply Current	I+	R_{SET} = open circuit			8	mA
		All segments and decimal point on, $I_{SEG_}$ = -40mA		330		mA
Display Scan Rate	f_{OSC}	8 digits scanned	500	800	1300	Hz
Digit Drive Sink Current	I_{DIGIT}	V+ = 5V, V_{OUT} = 0.65V	320			mA
Segment Drive Source Current	I_{SEG}	T_A = +25°C, V+ = 5V, V_{OUT} = (V+ - 1V)	-30	-40	-45	mA
Segment Current Slew Rate (MAX7221 only)	$\Delta I_{SEG}/\Delta t$	T_A = +25°C, V+ = 5V, V_{OUT} = (V+ - 1V)	10	20	50	mA/µs
Segment Drive Current Matching	ΔI_{SEG}			3.0		%
Digit Drive Leakage (MAX7221 only)	I_{DIGIT}	Digit off, V_{DIGIT} = V+			-10	µA
Segment Drive Leakage (MAX7221 only)	I_{SEG}	Segment off, V_{SEG} = 0V			1	µA
Digit Drive Source Current (MAX7219 only)	I_{DIGIT}	Digit off, V_{DIGIT} = (V+ - 0.3V)	-2			mA
Segment Drive Sink Current (MAX7219 only)	I_{SEG}	Segment off, V_{SEG} = 0.3V	5			mA

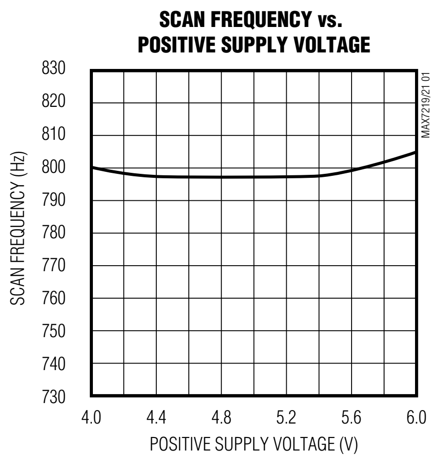
ELECTRICAL CHARACTERISTICS (continued)

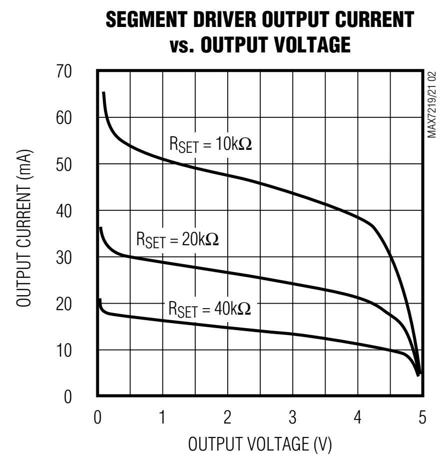
($V+ = 5V \pm 10\%$, $R_{SET} = 9.53k\Omega \pm 1\%$, $T_A = T_{MIN}$ to T_{MAX}, unless otherwise noted.)

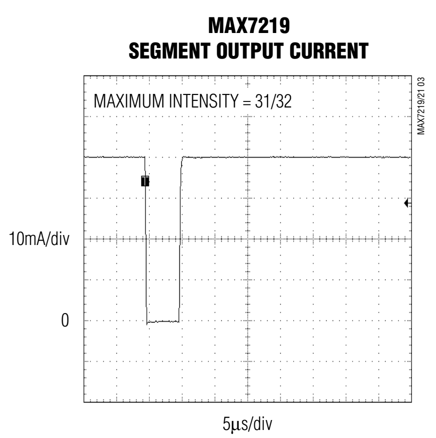
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC INPUTS						
Input Current DIN, CLK, LOAD, $\overline{CS}$	I_{IH}, I_{IL}	V_{IN} = 0V or V+	-1		1	µA
Logic High Input Voltage	V_{IH}		3.5			V
Logic Low Input Voltage	V_{IL}				0.8	V
Output High Voltage	V_{OH}	DOUT, I_{SOURCE} = -1mA	V+ - 1			V
Output Low Voltage	V_{OL}	DOUT, I_{SINK} = 1.6mA			0.4	V
Hysteresis Voltage	ΔV_I	DIN, CLK, LOAD, $\overline{CS}$		1		V
TIMING CHARACTERISTICS						
CLK Clock Period	t_{CP}		100			ns
CLK Pulse Width High	t_{CH}		50			ns
CLK Pulse Width Low	t_{CL}		50			ns
$\overline{CS}$ Fall to SCLK Rise Setup Time (MAX7221 only)	t_{CSS}		25			ns
CLK Rise to $\overline{CS}$ or LOAD Rise Hold Time	t_{CSH}		0			ns
DIN Setup Time	t_{DS}		25			ns
DIN Hold Time	t_{DH}		0			ns
Output Data Propagation Delay	t_{DO}	C_{LOAD} = 50pF			25	ns
Load-Rising Edge to Next Clock Rising Edge (MAX7219 only)	t_{LDCK}		50			ns
Minimum $\overline{CS}$ or LOAD Pulse High	t_{CSW}		50			ns
Data-to-Segment Delay	t_{DSPD}				2.25	ms

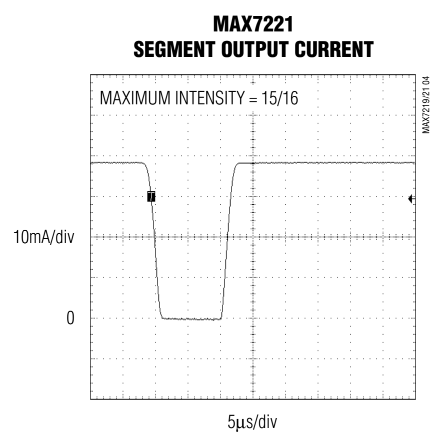
Typical Operating Characteristics

(V+ = +5V, T_A = +25°C, unless otherwise noted.)





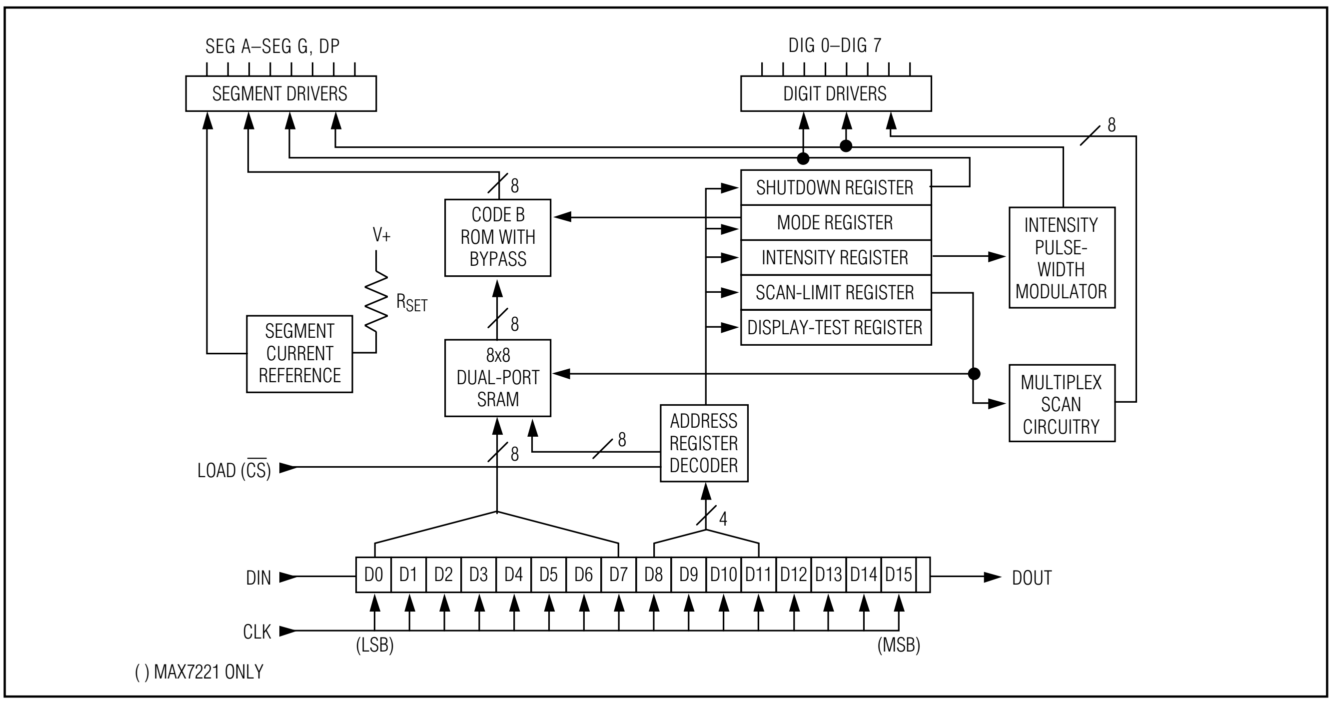




Pin Description

PIN	NAME	FUNCTION
1	DIN	Serial-Data Input. Data is loaded into the internal 16-bit shift register on CLK's rising edge.
2, 3, 5–8, 10, 11	DIG 0–DIG 7	Eight-Digit Drive Lines that sink current from the display common cathode. The MAX7219 pulls the digit outputs to V+ when turned off. The MAX7221's digit drivers are high-impedance when turned off.
4, 9	GND	Ground (both GND pins must be connected)
12	LOAD (MAX7219)	Load-Data Input. The last 16 bits of serial data are latched on LOAD's rising edge.
	$\overline{CS}$ (MAX7221)	Chip-Select Input. Serial data is loaded into the shift register while $\overline{CS}$ is low. The last 16 bits of serial data are latched on $\overline{CS}$'s rising edge.
13	CLK	Serial-Clock Input. 10MHz maximum rate. On CLK's rising edge, data is shifted into the internal shift register. On CLK's falling edge, data is clocked out of DOUT. On the MAX7221, the CLK input is active only while $\overline{CS}$ is low.
14–17, 20–23	SEG A–SEG G, DP	Seven Segment Drives and Decimal Point Drive that source current to the display. On the MAX7219, when a segment driver is turned off it is pulled to GND. The MAX7221 segment drivers are high-impedance when turned off.
18	ISET	Connect to V_{DD} through a resistor (R_{SET}) to set the peak segment current (Refer to *Selecting R_{SET} Resistor* section).
19	V+	Positive Supply Voltage. Connect to +5V.
24	DOUT	Serial-Data Output. The data into DIN is valid at DOUT 16.5 clock cycles later. This pin is used to daisy-chain several MAX7219/MAX7221's and is never high-impedance.

Functional Diagram



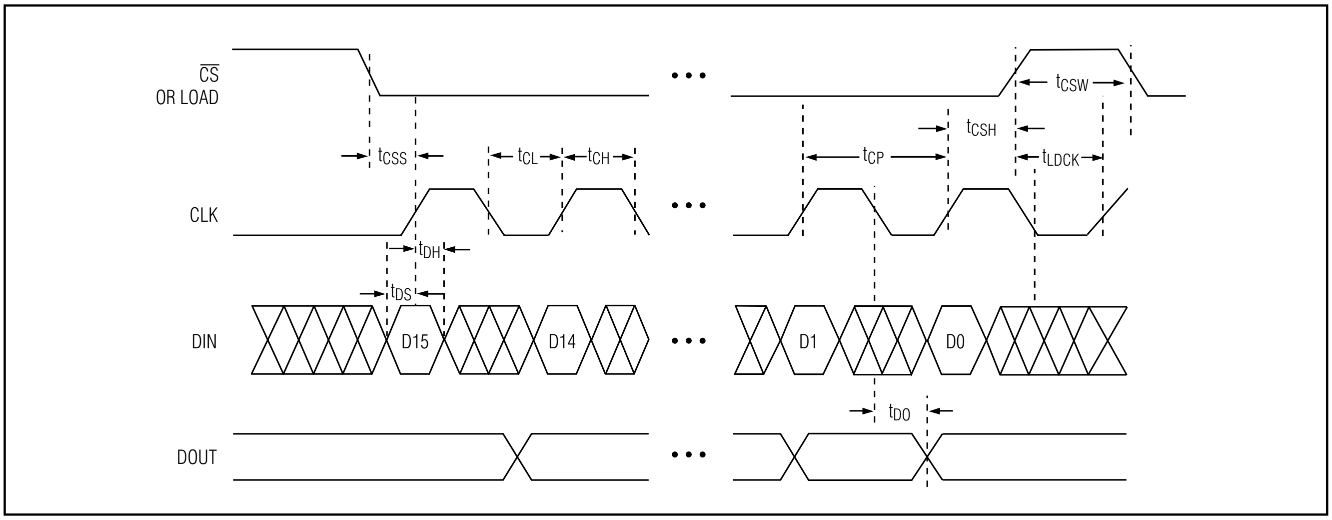


Figure 1. Timing Diagram

Table 1. Serial-Data Format (16 Bits)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
X	X	X	X		ADDRESS			MSB			DATA				LSB

Detailed Description

MAX7219/MAX7221 Differences

The MAX7219 and MAX7221 are identical except for two parameters: the MAX7221 segment drivers are slew-rate limited to reduce electromagnetic interference (EMI), and its serial interface is fully SPI compatible.

Serial-Addressing Modes

For the MAX7219, serial data at DIN, sent in 16-bit packets, is shifted into the internal 16-bit shift register with each rising edge of CLK regardless of the state of LOAD. For the MAX7221, $\overline{CS}$ must be low to clock data in or out. The data is then latched into either the digit or control registers on the rising edge of LOAD/$\overline{CS}$. LOAD/$\overline{CS}$ must go high concurrently with or after the 16th rising clock edge, but before the next rising clock edge or data will be lost. Data at DIN is propagated through the shift register and appears at DOUT 16.5 clock cycles later. Data is clocked out on the falling edge of CLK. Data bits are labeled D0–D15 (Table 1). D8–D11 contain the register address. D0–D7 contain the data, and D12–D15 are “don’t care” bits. The first received is D15, the most significant bit (MSB).

Digit and Control Registers

Table 2 lists the 14 addressable digit and control registers. The digit registers are realized with an on-chip, 8x8 dual-port SRAM. They are addressed directly so that individual digits can be updated and retain data as long as V+ typically exceeds 2V. The control registers consist of decode mode, display intensity, scan limit (number of scanned digits), shutdown, and display test (all LEDs on).

Shutdown Mode

When the MAX7219 is in shutdown mode, the scan oscillator is halted, all segment current sources are pulled to ground, and all digit drivers are pulled to V+, thereby blanking the display. The MAX7221 is identical, except the drivers are high-impedance. Data in the digit and control registers remains unaltered. Shutdown can be used to save power or as an alarm to flash the display by successively entering and leaving shutdown mode. For minimum supply current in shutdown mode, logic inputs should be at ground or V+ (CMOS-logic levels).

Typically, it takes less than 250µs for the MAX7219/MAX7221 to leave shutdown mode. The display driver can be programmed while in shutdown mode, and shutdown mode can be overridden by the display-test function.

Table 2. Register Address Map

REGISTER	ADDRESS					HEX CODE
	D15–D12	D11	D10	D9	D8	
No-Op	X	0	0	0	0	0xX0
Digit 0	X	0	0	0	1	0xX1
Digit 1	X	0	0	1	0	0xX2
Digit 2	X	0	0	1	1	0xX3
Digit 3	X	0	1	0	0	0xX4
Digit 4	X	0	1	0	1	0xX5
Digit 5	X	0	1	1	0	0xX6
Digit 6	X	0	1	1	1	0xX7
Digit 7	X	1	0	0	0	0xX8
Decode Mode	X	1	0	0	1	0xX9
Intensity	X	1	0	1	0	0xXA
Scan Limit	X	1	0	1	1	0xXB
Shutdown	X	1	1	0	0	0xXC
Display Test	X	1	1	1	1	0xXF

Initial Power-Up

On initial power-up, all control registers are reset, the display is blanked, and the MAX7219/MAX7221 enter shutdown mode. Program the display driver prior to display use. Otherwise, it will initially be set to scan one digit, it will not decode data in the data registers, and the intensity register will be set to its minimum value.

Decode-Mode Register

The decode-mode register sets BCD code B (0-9, E, H, L, P, and -) or no-decode operation for each digit. Each bit in the register corresponds to one digit. A logic high selects code B decoding while logic low bypasses the decoder. Examples of the decode mode control-register format are shown in Table 4.

When the code B decode mode is used, the decoder looks only at the lower nibble of the data in the digit registers (D3–D0), disregarding bits D4–D6. D7, which sets the decimal point (SEG DP), is independent of the decoder and is positive logic (D7 = 1 turns the decimal point on). Table 5 lists the code B font.

When no-decode is selected, data bits D7–D0 correspond to the segment lines of the MAX7219/MAX7221. Table 6 shows the one-to-one pairing of each data bit to the appropriate segment line.

Table 3. Shutdown Register Format (Address (Hex) = 0xXC)

MODE	ADDRESS CODE (HEX)	REGISTER DATA							
		D7	D6	D5	D4	D3	D2	D1	D0
Shutdown Mode	0xXC	X	X	X	X	X	X	X	0
Normal Operation	0xXC	X	X	X	X	X	X	X	1

Table 4. Decode-Mode Register Examples (Address (Hex) = 0xX9)

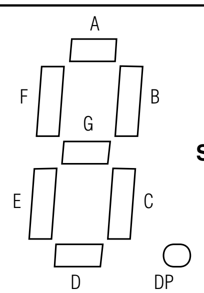
DECODE MODE	REGISTER DATA								HEX CODE
	D7	D6	D5	D4	D3	D2	D1	D0	
No decode for digits 7–0	0	0	0	0	0	0	0	0	0x00
Code B decode for digit 0 No decode for digits 7–1	0	0	0	0	0	0	0	1	0x01
Code B decode for digits 3–0 No decode for digits 7–4	0	0	0	0	1	1	1	1	0x0F
Code B decode for digits 7–0	1	1	1	1	1	1	1	1	0xFF

Table 5. Code B Font

7-SEGMENT CHARACTER	REGISTER DATA						ON SEGMENTS = 1							
	D7*	D6–D4	D3	D2	D1	D0	DP*	A	B	C	D	E	F	G
0		X	0	0	0	0		1	1	1	1	1	1	0
1		X	0	0	0	1		0	1	1	0	0	0	0
2		X	0	0	1	0		1	1	0	1	1	0	1
3		X	0	0	1	1		1	1	1	1	0	0	1
4		X	0	1	0	0		0	1	1	0	0	1	1
5		X	0	1	0	1		1	0	1	1	0	1	1
6		X	0	1	1	0		1	0	1	1	1	1	1
7		X	0	1	1	1		1	1	1	0	0	0	0
8		X	1	0	0	0		1	1	1	1	1	1	1
9		X	1	0	0	1		1	1	1	1	0	1	1
—		X	1	0	1	0		0	0	0	0	0	0	1
E		X	1	0	1	1		1	0	0	1	1	1	1
H		X	1	1	0	0		0	1	1	0	1	1	1
L		X	1	1	0	1		0	0	0	1	1	1	0
P		X	1	1	1	0		1	1	0	0	1	1	1
blank		X	1	1	1	1		0	0	0	0	0	0	0

*The decimal point is set by bit D7 = 1

Table 6. No-Decode Mode Data Bits and Corresponding Segment Lines



STANDARD 7-SEGMENT LED

	REGISTER DATA							
	D7	D6	D5	D4	D3	D2	D1	D0
Corresponding Segment Line	DP	A	B	C	D	E	F	G

Intensity Control and Interdigit Blanking

The MAX7219/MAX7221 allow display brightness to be controlled with an external resistor (R_{SET}) connected between V+ and ISET. The peak current sourced from the segment drivers is nominally 100 times the current entering ISET. This resistor can either be fixed or variable to allow brightness adjustment from the front panel. Its minimum value should be 9.53kΩ, which typically sets the segment current at 40mA. Display brightness can also be controlled digitally by using the intensity register.

Digital control of display brightness is provided by an internal pulse-width modulator, which is controlled by the lower nibble of the intensity register. The modulator scales the average segment current in 16 steps from a maximum of 31/32 down to 1/32 of the peak current set by R_{SET} (15/16 to 1/16 on MAX7221). Table 7 lists the intensity register format. The minimum interdigit blanking time is set to 1/32 of a cycle.

Table 7. Intensity Register Format (Address (Hex) = 0xXA)

DUTY CYCLE		D7	D6	D5	D4	D3	D2	D1	D0	HEX CODE
MAX7219	**MAX7221**									
1/32 (min on)	1/16 (min on)	X	X	X	X	0	0	0	0	0xX0
3/32	2/16	X	X	X	X	0	0	0	1	0xX1
5/32	3/16	X	X	X	X	0	0	1	0	0xX2
7/32	4/16	X	X	X	X	0	0	1	1	0xX3
9/32	5/16	X	X	X	X	0	1	0	0	0xX4
11/32	6/16	X	X	X	X	0	1	0	1	0xX5
13/32	7/16	X	X	X	X	0	1	1	0	0xX6
15/32	8/16	X	X	X	X	0	1	1	1	0xX7
17/32	9/16	X	X	X	X	1	0	0	0	0xX8
19/32	10/16	X	X	X	X	1	0	0	1	0xX9
21/32	11/16	X	X	X	X	1	0	1	0	0xXA
23/32	12/16	X	X	X	X	1	0	1	1	0xXB
25/32	13/16	X	X	X	X	1	1	0	0	0xXC
27/32	14/16	X	X	X	X	1	1	0	1	0xXD
29/32	15/16	X	X	X	X	1	1	1	0	0xXE
31/32	15/16 (max on)	X	X	X	X	1	1	1	1	0xXF

Table 8. Scan-Limit Register Format (Address (Hex) = 0xXB)

SCAN LIMIT	REGISTER DATA								HEX CODE
	D7	**D6**	**D5**	**D4**	**D3**	**D2**	**D1**	**D0**	
Display digit 0 only*	X	X	X	X	X	0	0	0	0xX0
Display digits 0 & 1*	X	X	X	X	X	0	0	1	0xX1
Display digits 0 1 2*	X	X	X	X	X	0	1	0	0xX2
Display digits 0 1 2 3	X	X	X	X	X	0	1	1	0xX3
Display digits 0 1 2 3 4	X	X	X	X	X	1	0	0	0xX4
Display digits 0 1 2 3 4 5	X	X	X	X	X	1	0	1	0xX5
Display digits 0 1 2 3 4 5 6	X	X	X	X	X	1	1	0	0xX6
Display digits 0 1 2 3 4 5 6 7	X	X	X	X	X	1	1	1	0xX7

*See *Scan-Limit Register* section for application.

Scan-Limit Register

The scan-limit register sets how many digits are displayed, from 1 to 8. They are displayed in a multiplexed manner with a typical display scan rate of 800Hz with 8 digits displayed. If fewer digits are displayed, the scan rate is $8f_{OSC}/N$, where N is the number of digits scanned. Since the number of scanned digits affects the display brightness, the scan-limit register should not be used to blank portions of the display (such as leading zero suppression). Table 8 lists the scan-limit register format.

If the scan-limit register is set for three digits or less, individual digit drivers will dissipate excessive amounts of power. Consequently, the value of the R_{SET} resistor must be adjusted according to the number of digits displayed, to limit individual digit driver power dissipation. Table 9 lists the number of digits displayed and the corresponding maximum recommended segment current when the digit drivers are used.

Display-Test Register

The display-test register operates in two modes: normal and display test. Display-test mode turns all LEDs on by overriding, but not altering, all controls and digit registers (including the shutdown register). In display-test mode, 8 digits are scanned and the duty cycle is 31/32 (15/16 for MAX7221). Table 10 lists the display-test register format.

Table 9. Maximum Segment Current for 1-, 2-, or 3-Digit Displays

NUMBER OF DIGITS DISPLAYED	MAXIMUM SEGMENT CURRENT (mA)
1	10
2	20
3	30

Table 10. Display-Test Register Format (Address (Hex) = 0xXF)

MODE	REGISTER DATA							
	D7	D6	D5	D4	D3	D2	D1	D0
Normal Operation	X	X	X	X	X	X	X	0
Display Test Mode	X	X	X	X	X	X	X	1

Note: The MAX7219/MAX7221 remain in display-test mode (all LEDs on) until the display-test register is reconfigured for normal operation.

No-Op Register

The no-op register is used when cascading MAX7219s or MAX7221s. Connect all devices' LOAD/$\overline{CS}$ inputs together and connect DOUT to DIN on adjacent devices. DOUT is a CMOS logic-level output that easily drives DIN of successively cascaded parts. (Refer to the *Serial Addressing Modes* section for detailed information on serial input/output timing.) For example, if four MAX7219s are cascaded, then to write to the fourth chip, sent the desired 16-bit word, followed by three no-op codes (hex 0xXX0X, see Table 2). When LOAD/$\overline{CS}$ goes high, data is latched in all devices. The first three chips receive no-op commands, and the fourth receives the intended data.

Applications Information

Supply Bypassing and Wiring

To minimize power-supply ripple due to the peak digit driver currents, connect a 10µF electrolytic and a 0.1µF ceramic capacitor between V+ and GND as close to the device as possible. The MAX7219/MAX7221 should be placed in close proximity to the LED display, and connections should be kept as short as possible to minimize the effects of wiring inductance and electromagnetic interference. Also, both GND pins must be connected to ground.

Selecting R_{SET} Resistor and Using External Drivers

The current per segment is approximately 100 times the current in ISET. To select R_{SET}, see Table 11. The MAX7219/MAX7221's maximum recommended segment current is 40mA. For segment current levels above these levels, external digit drivers will be needed. In this application, the MAX7219/MAX7221 serve only as controllers for other high-current drivers or transistors. Therefore, to conserve power, use R_{SET} = 47kΩ when using external current sources as segment drivers.

The example in Figure 2 uses the MAX7219/MAX7221's segment drivers, a MAX394 single-pole double-throw analog switch, and external transistors to drive 2.3" AND2307SLC common-cathode displays. The 5.6V zener diode has been added in series with the decimal point LED because the decimal point LED forward voltage is typically 4.2V. For all other segments the LED forward voltage is typically 8V. Since external transistors are used to sink current (DIG 0 and DIG 1 are used as logic switches), peak segment currents of 45mA are allowed even though only two digits are displayed. In applications where the MAX7219/MAX7221's digit drivers are used to sink current and fewer than four digits are displayed, Table 9 specifies the maximum allowable segment current. R_{SET} must be selected accordingly (Table 11).

Refer to the Power Dissipation section of the Absolute Maximum Ratings to calculate acceptable limits for ambient temperature, segment current, and the LED forward-voltage drop.

Table 11. R_{SET} vs. Segment Current and LED Forward Voltage

I_{SEG} (mA)	V_{LED} (V)				
	1.5	**2.0**	**2.5**	**3.0**	**3.5**
40	12.2	11.8	11.0	10.6	9.69
30	17.8	17.1	15.8	15.0	14.0
20	29.8	28.0	25.9	24.5	22.6
10	66.7	63.7	59.3	55.4	51.2

Table 12. Package Thermal Resistance Data

PACKAGE	THERMAL RESISTANCE (θ_{JA})
24 Narrow DIP	+75°C/W
24 Wide SO	+85°C/W
24 CERDIP	+80°C/W
Maximum Junction Temperature (T_J) = +150°C	
Maximum Ambient Temperature (T_A) = +85°C	

Computing Power Dissipation

The upper limit for power dissipation (PD) for the MAX7219/MAX7221 is determined from the following equation:

$$PD = (V+ \times 8mA) + (V+ - V_{LED})(DUTY \times I_{SEG} \times N)$$

where:

V+ = supply voltage

DUTY = duty cycle set by intensity register

N = number of segments driven (worst case is 8)

V_{LED} = LED forward voltage

I_{SEG} = segment current set by R_{SET}

Dissipation Example:

I_{SEG} = 40mA, N = 8, DUTY = 31/32, V_{LED} = 1.8V at 40mA, V+ = 5.25V

PD = 5.25V(8mA) + (5.25V - 1.8V)(31/32 x 40mA x 8) = 1.11W

Thus, for a CERDIP package (θ_{JA} = +80°C/W from Table 12), the maximum allowed ambient temperature T_A is given by:

$$T_{J(MAX)} = T_A + PD \times \theta_{JA} + 150°C = T_A + 1.11W \times 80°C/W$$

where T_A = +61.2°C.

The T_A limits for PDIP and SO Packages in the dissipation example above are +66.7°C and +55.6°C, respectively.

Cascading Drivers

The example in Figure 3 drives 16 digits using a 3-wire µP interface. If the number of digits is not a multiple of 8, set both drivers' scan limits registers to the same number so one display will not appear brighter than the other. For example, if 12 digits are need, use 6 digits per display with both scan-limit registers set for 6 digits so that both displays have a 1/6 duty cycle per digit. If 11 digits are needed, set both scan-limit registers for 6 digits and leave one digit driver unconnected. If one display for 6 digits and the other for 5 digits, the second display will appear brighter because its duty cycle per digit will be 1/5 while the first display's will be 1/6. Refer to the *No-Op Register* section for additional information.

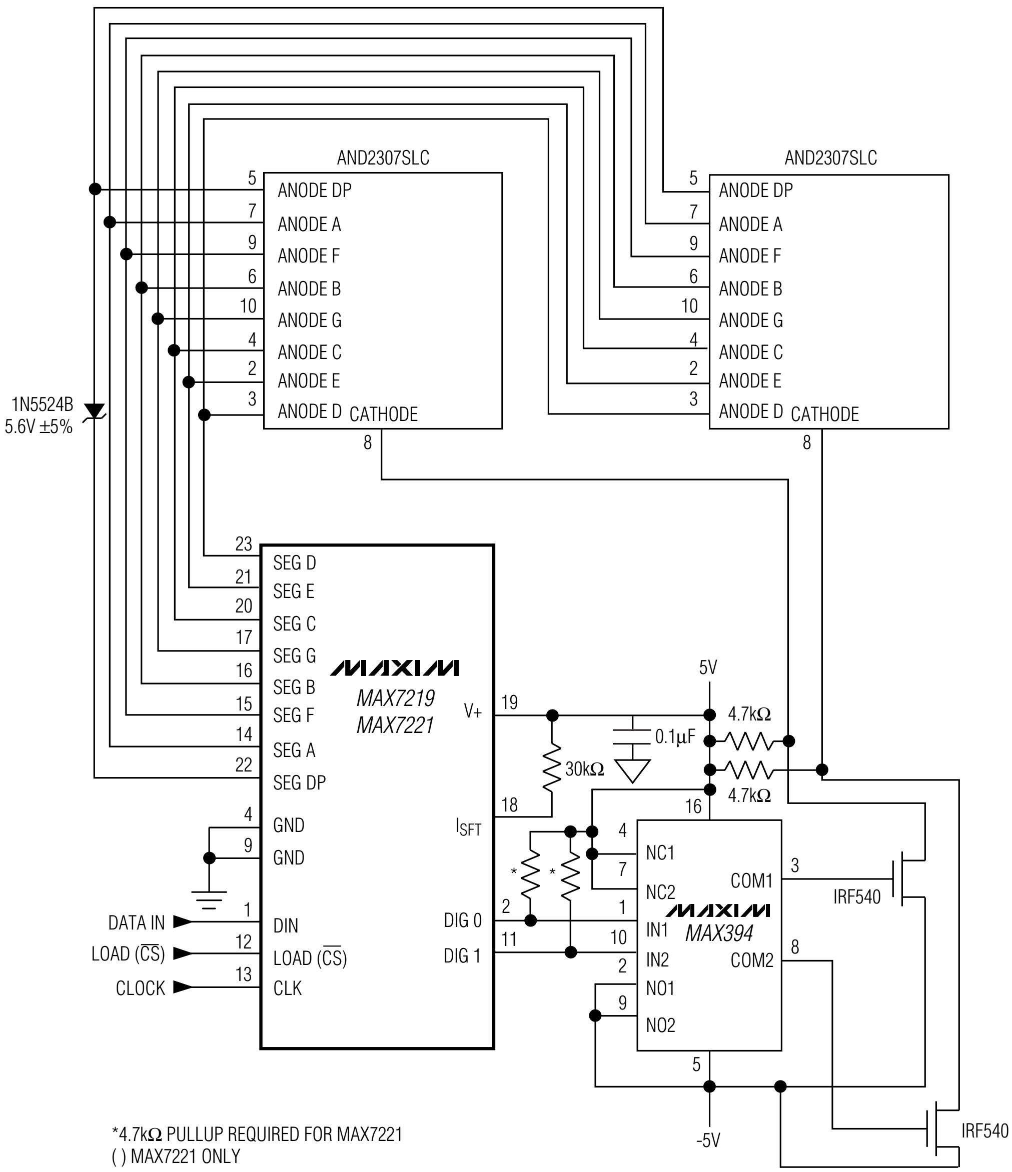


Figure 2. MAX7219/MAX7221 Driving 2.3in Displays

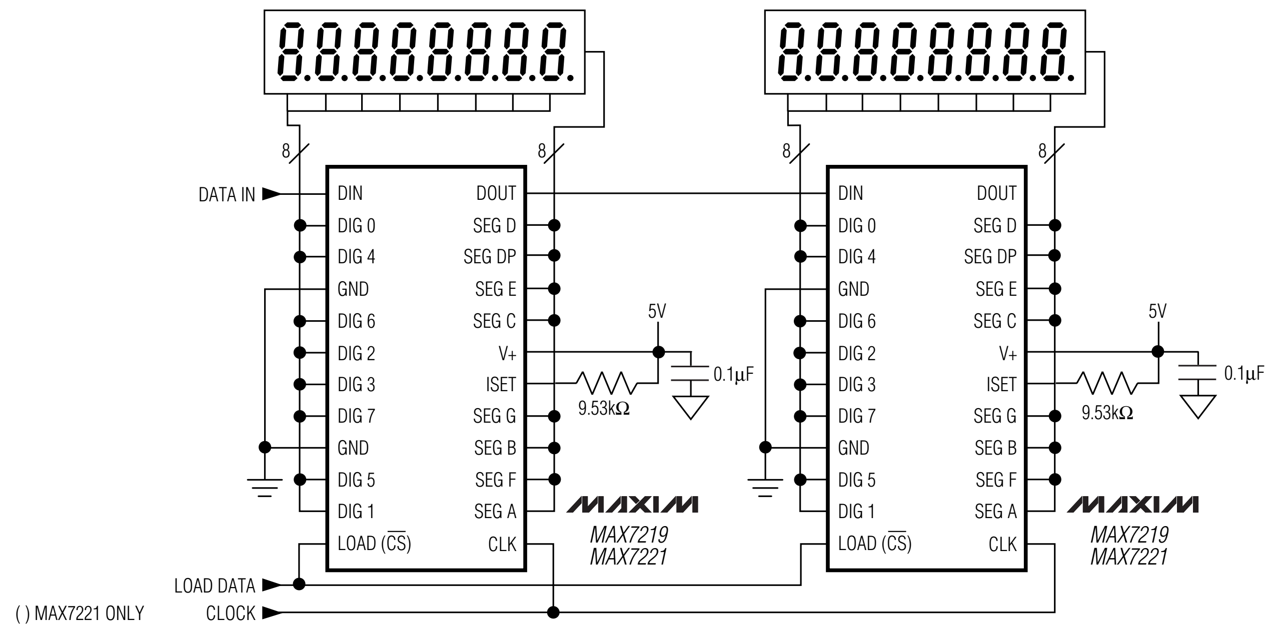


Figure 3. Cascading MAX7219/MAX7221s to Drive 16 Seven-Segment LED Digits

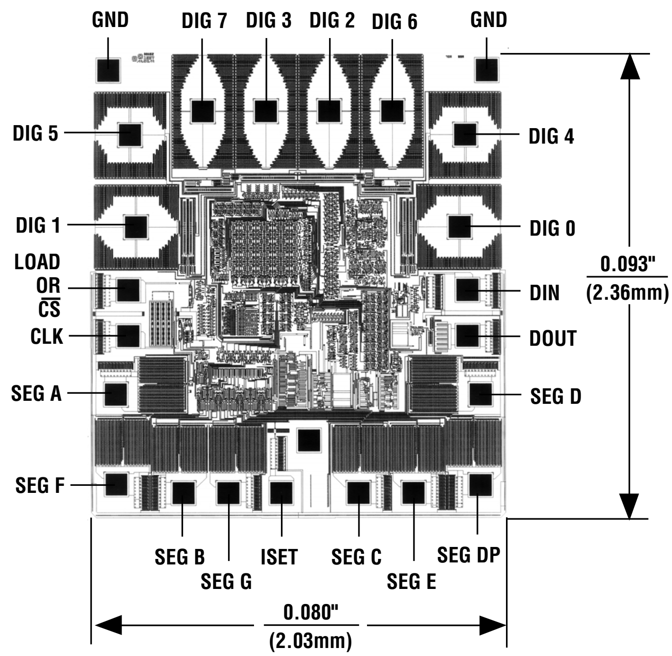
Serially Interfaced, 8-Digit LED Display Drivers

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX7221CNG	0°C to +70°C	24 Narrow Plastic DIP
MAX7221CWG	0°C to +70°C	24 Wide SO
MAX7221C/D	0°C to +70°C	Dice*
MAX7221ENG	-40°C to +85°C	24 Narrow Plastic DIP
MAX7221EWG	-40°C to +85°C	24 Wide SO
MAX7221ERG	-40°C to +85°C	24 Narrow CERDIP

Dice are specified at T_A = +25°C.

Chip Topography



TRANSISTOR COUNT: 5267

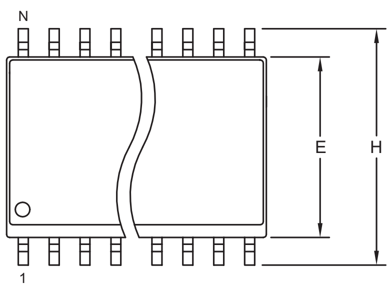
SUBSTRATE CONNECTED TO GND

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

SOICW.EPS

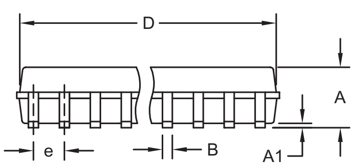
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.093	0.104	2.35	2.65
A1	0.004	0.012	0.10	0.30
B	0.014	0.019	0.35	0.49
C	0.009	0.013	0.23	0.32
e	0.050		1.27	
E	0.291	0.299	7.40	7.60
H	0.394	0.419	10.00	10.65
L	0.016	0.050	0.40	1.27



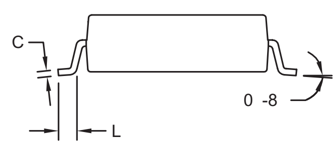
TOP VIEW

VARIATIONS:

	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX	N	MS013
D	0.398	0.413	10.10	10.50	16	AA
D	0.447	0.463	11.35	11.75	18	AB
D	0.496	0.512	12.60	13.00	20	AC
D	0.598	0.614	15.20	15.60	24	AD
D	0.697	0.713	17.70	18.10	28	AE



FRONT VIEW



SIDE VIEW

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. LEADS TO BE COPLANAR WITHIN 0.10mm (.004").
4. CONTROLLING DIMENSION: MILLIMETERS.
5. MEETS JEDEC MS013.
6. N = NUMBER OF PINS.

DALLAS SEMICONDUCTOR MAXIM

PROPRIETARY INFORMATION

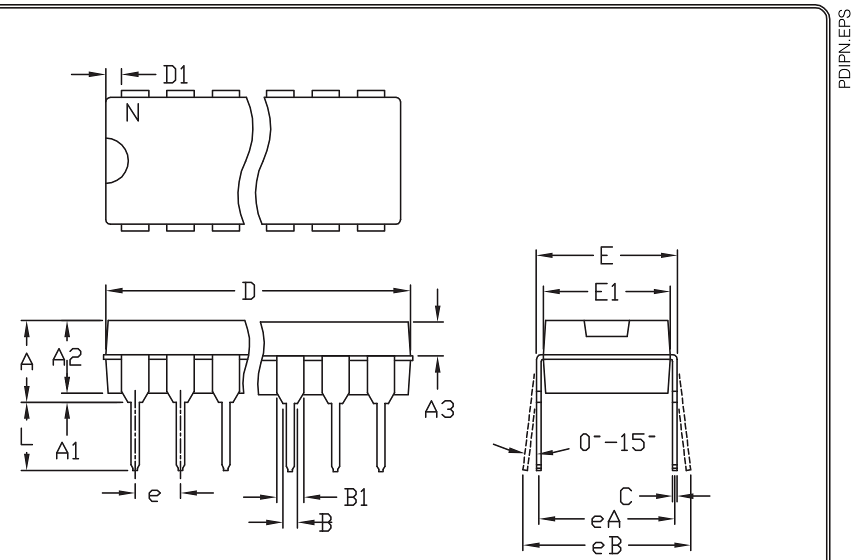
TITLE:

PACKAGE OUTLINE, .300" SOIC

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0042	B	1/1

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.180	---	4.572
A1	0.015	---	0.38	---
A2	0.125	0.175	3.18	4.45
A3	0.055	0.080	1.40	2.03
B	0.015	0.022	0.381	0.56
B1	0.045	0.065	1.14	1.65
C	0.008	0.014	0.2	0.355
D1	0.005	0.080	0.13	2.03
E	0.300	0.325	7.62	8.26
E1	0.240	0.310	6.10	7.87
e	0.100 BSC.		2.54 BSC.	
eA	0.300 BSC.		7.62 BSC.	
eB	0.400 BSC.		10.16 BSC.	
L	0.115	0.150	2.921	3.81

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS001
D	0.348	0.390	8.84	9.91	8	AB
D	0.735	0.765	18.67	19.43	14	AC
D	0.745	0.765	18.92	19.43	16	AA
D	0.885	0.915	22.48	23.24	18	AD
D	1.015	1.045	25.78	26.54	20	AE
D	1.14	1.265	28.96	32.13	24	AF
D	1.360	1.380	34.54	35.05	28	*5

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC MS001-XX AS SHOWN IN ABOVE TABLE
5. SIMILIAR TO JEDEC MO-058AB
6. N = NUMBER OF PINS

MAXIM 120 SAN GABRIEL DR. SUNNYVALE CA 94086 FAX (408) 737 7194 PROPRIETARY INFORMATION	TITLE: PACKAGE FAMILY OUTLINE: PDIP .300"	1/1	DOCUMENT CONTROL NUMBER: 21-0043	REV: D

承 认 书

SPECIFCATION

	客 户 资 料 CUSTOMER's INFORMATION
产品名称 LED 数码管 PRODUCTION NAME:	
产品型号: LD788BS-SS22 PRODCTION TYPE:	机型: MODEL NO:
规格摘要: TYPE:红光 788 点阵管	料号: PART NO:

日期:2010-10-25 DATE:	承办人: ISSUEDER:

客户确认 APPROVED BY		
	签名 SIGN:	日期 DATE:
结论 RESULT		

确认后请回传 PLEASE RETURN BY ONE COPY

1 型号 PART NO LD788BS-SS22

2 说明 Description

发光颜色 Emitted Color 红光
外观颜色 Lens Color 黑、白两色
外形尺寸 Max Size 20.00*20.00*5.90

极限参数 Absolute Maximum Ratings ——→建议使用驱动检测

参数 Parameter	单位 Symbol	极限值 Maximum Rating	单位 Unit
功耗 Power Dissipation	Pd		mW
脉冲电流 Peak Forward Current	Ifp	150	mA
直流电流 Continuous Forward Current Forward)Current	Ifm	20	mA
反向电压 Reverse Voltage	V_R	5	V
工作温度 Operating Temperature Range	Topr	-40 → +85	℃
储藏温度 Storage Temperature Range	Tstg	-40 → +100	℃
静电电压 Static Voltage	Var		V

*焊接温度 Lead Sodering Temperature 260℃ for 3 seconds

*当工作温度高于 25℃时，Ifm,Ifp 和 Id 必须降低；电流降低率是-0.36mA/℃ 直流驱动），或-0.86mA/℃ 脉冲驱动 功耗降低率是-0.75mW/℃ 产品的工作电流不能大于对应工作温度条件 Ifm 或 Ifp 的 60%

For operation above 25℃, The Ifm Ifp & Pd must be derated, the Curent derating is –0.36mA/℃ for DC drive and -0.86mA/℃ for Pulse drive, the power dissipation is -0.75mW/℃. The product working current must not more than the 60% of the Ifm or Ifp according to the working temperature.

光电特性 Optical-Electrical Characteristic ——→ 建议使用驱动检测

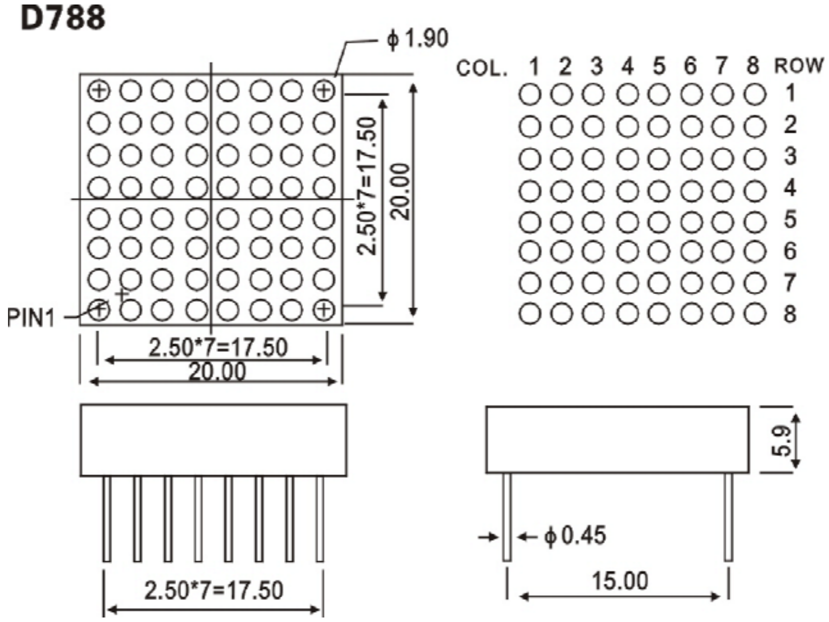
参数 Parameter	测试条件 Test CONDITING	单位 Symbol	Min	Type	Max	单位 Unit
发光强度 Luminous Intensity	I_F=10mA	Iv	21.8	25.9	28.4	Mcd
正向电压 Forward Voltage	I_F=10mA	V_F	-	2.01	-	V
反向电流 REVERSE Current	V_R = 5V	I_R	-	20		uA
波长 Peak Wavelength	I_F=10mA	155.7	630.8	631.7	634.3	nm
带宽 Spectral Bandwidth	I_F=10mA	△λ	-	40	-	nm
查看角度 View Angle	I_F=10mA	$2\theta_{1/2}$	-		-	Deg.

3.结构尺寸 Mechanical Outline :

(未注尺寸公差 Unspecified Tolerances is: X±0.2

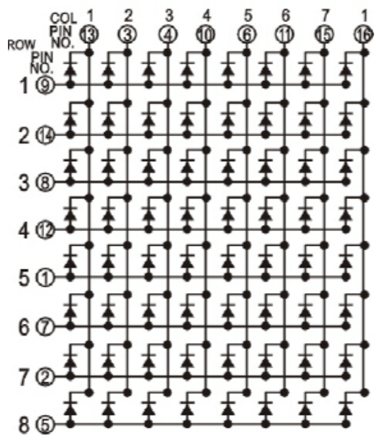
发光颜色 红色
COLOR

D788



.电路图 Circuit Diagram :

PCB:FJ788A/B



5.保存和焊接条件 Storage & Soldering Condions :

- Store with care. Storing the units in bad condition will cause the reflector sheet and decrease it’s adhesive power. Storage the products under the condition :temperature (25℃ ± 10℃) and humidity (65℃ CRH±20℃ CRH) our recommendation.
  注意保存，保存条件不好时，会降低膜片与反射壳 导光板 的粘附力
  推荐保存条件为 温度 25℃±10℃
  湿度 65℃CRH±20℃CRH
- The Soldering Temperature is 260±5℃ and Soldering Time should be less than 3 sec, and soldering iron power should be less than 30W.
  焊接温度 260℃±5℃，焊接时间小于 3 秒，烙铁功率小于 30W
- The soldering point should be farther than 1.6mm from boby.
  焊接点应离产品实体大于 1.6mm